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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Kejun Zeng

Art Unit 1725

AppNo. 10/797,779

Examiner Edmondson

Filed 03/09/2004

TI-36626

For Method of Semiconductor Device Assembly Including
Fatigue-Resistant Ternary Solder Alloy

AMENDMENT - 37 CFR 1.115

Commissioner for Patents

PO Box 1450

Alexandria, Virginia 22313-1450

Sir:

Responsive to the Office Action of 09/02/2005, favorable reconsideration and allowance of the application are respectfully requested in view of the following amendments.



Claim Amendments

Please cancel claims 5 and 7.

A complete listing of the claims is attached.